**New Product** 



#### Si4228DY

RoHS

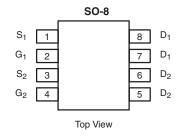
COMPLIANT HALOGEN

FREE

Vishay Siliconix

### Dual N-Channel 25 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                    |                       |  |  |  |
|---------------------|----------------------------------|------------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | <b>R<sub>DS(on)</sub> (</b> Ω)   | I <sub>D</sub> (A) <sup>a, e</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
|                     | 0.018 at V <sub>GS</sub> = 10 V  | 8                                  |                       |  |  |  |
| 25                  | 0.020 at V <sub>GS</sub> = 4.5 V | 8                                  | 7.8 nC                |  |  |  |
|                     | 0.024 at V <sub>GS</sub> = 2.5 V | 7.5                                |                       |  |  |  |



#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

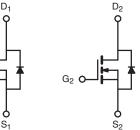
#### **APPLICATIONS**

•

- Synchronous Buck Converter
  - DC/DC Converter

N-Channel MOSFET

G



N-Channel MOSFET

Ordering Information: Si4228DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter  | Symbol                 | Limit                             | Unit                 |    |
|--|------------------------|-----------------------------------|----------------------|----|
| Drain-Source Voltage                               |                        | V <sub>DS</sub>                   | 25                   | v  |
| Gate-Source Voltage                                |                        | V <sub>GS</sub>                   | ± 12                 | v  |
|  | T <sub>C</sub> = 25 °C |                                   | 8 <sup>e</sup>       |    |
|  | T <sub>C</sub> = 70 °C |                                   | 8 <sup>e</sup>       |    |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C | I <sub>D</sub>                    | 8 <sup>b, c, e</sup> |    |
|  | T <sub>A</sub> = 70 °C |                                   | 6.9 <sup>b, c</sup>  | •  |
| Pulsed Drain Current                               |                        | I <sub>DM</sub>                   | 50                   | A  |
| Continuous Source-Drain Diode Current              | T <sub>C</sub> = 25 °C | - I <sub>S</sub>                  | 2.6                  |    |
|  | T <sub>A</sub> = 25 °C |                                   | 1.7 <sup>b, c</sup>  |    |
| Single Pulse Avalanche Current                     |                        | I <sub>AS</sub>                   | 15                   |    |
| Avalanche Energy                                   | L = 0.1 mH             | E <sub>AS</sub>                   | 11.25                | mJ |
|  | T <sub>C</sub> = 25 °C |                                   | 3.1                  |    |
| Maximum Dawar Dissinction                          | T <sub>C</sub> = 70 °C |                                   | 2                    | w  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C | P <sub>D</sub>                    | 2 <sup>b, c</sup>    | VV |
|  | T <sub>A</sub> = 70 °C |                                   | 1.3 <sup>b, c</sup>  |    |
| Operating Junction and Storage Temperature Range   |                        | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150          | °C |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |  |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 52      | 62.5    | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 30      | 40      | 0/11 |  |  |

Notes:

a. Based on  $T_C = 25 \ ^{\circ}C$ .

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 110  $^{\circ}\text{C/W}.$ 

e. Package limited.

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| Parameter                                     | Symbol                  | Test Conditions  | Min. | Тур.  | Max.     | Unit    |  |
|---|-------------------------|--|------|-------|----------|---------|--|
| Static  |                         |  |      | •     | •        |         |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$  | 25   |       |          | V       |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | – Ι <sub>D</sub> = 250 μΑ  |      | 20    |          | mV/°C   |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  |      | - 3.2 |          | - mv/-c |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$  | 0.6  |       | 1.4      | V       |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 V, V_{GS} = \pm 12 V$  |      |       | ± 100    | nA      |  |
| Zara Cata Valtaga Drain Current               |                         | $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$  |      |       | 1        |         |  |
| Zero Gate Voltage Drain Current               | IDSS                    | $V_{DS}$ = 25 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C   |      |       | 10       | μA      |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$  | 20   |       |          | А       |  |
|   |                         | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$   |      | 0.015 | 15 0.018 |         |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$  |      | 0.016 | 0.020    |         |  |
|   |                         | $V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$  |      | 0.020 | 0.024    |         |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7 A   |      | 68    |          | S       |  |
| Dynamic <sup>b</sup>                          |                         |  |      |       |          |         |  |
| Input Capacitance                             | C <sub>iss</sub>        |  |      | 790   |          | pF      |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS}$ = 12.5 V, $V_{GS}$ = 0 V, f = 1 MHz   |      | 146   |          |         |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |  |      | 76    |          |         |  |
| Total Gate Charge                             |                         | $V_{DS}$ = 12.5 V, $V_{GS}$ = 10 V, $I_{D}$ = 8.6 A  |      | 16.5  | 25       | nC      |  |
|   | Qg                      |  |      | 7.8   | 12       |         |  |
| Gate-Source Charge                            | Q <sub>gs</sub>         | $V_{DS}$ = 12.5 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 8.6 A   |      | 1.6   |          |         |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |  |      | 1.7   |          |         |  |
| Gate Resistance                               | R <sub>g</sub>          | f = 1 MHz  | 0.5  | 2.5   | 5        | Ω       |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 7     | 14       |         |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 12.5 V, $R_{L}$ = 1.8 $\Omega$  |      | 12    | 18       | - ns    |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong$ 6.9 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$                                       |      | 21    | 30       |         |  |
| Fall Time                                     | t <sub>f</sub>          |  |      | 10    | 20       |         |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 4     | 8        |         |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 12.5 V, $R_L$ = 1.8 $\Omega$  |      | 9     | 18       |         |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $\text{I}_\text{D}\cong$ 6.9 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$ |      | 20    | 30       |         |  |
| Fall Time                                     | t <sub>f</sub>          |  |      | 7     | 14       |         |  |
| Drain-Source Body Diode Characterist          | ics                     |  |      |       |          |         |  |
| Continuous Source-Drain Diode Current         | ۱ <sub>S</sub>          | T <sub>C</sub> = 25 °C   |      |       | 2.6      | ^       |  |
| Pulse Diode Forward Currenta                  | I <sub>SM</sub>         |  |      | T     | 50       | A       |  |
| Body Diode Voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = 6.9 A   |      | 0.82  | 1.2      | V       |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |  |      | 15    | 23       | ns      |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         |  |      | 6     | 12       | nC      |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = 6.9 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$          |      | 8     |          |         |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |  |      | 7     |          | ns      |  |

Notes

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

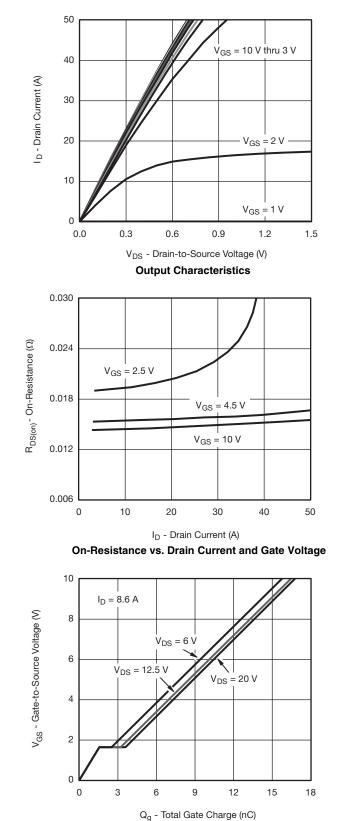
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

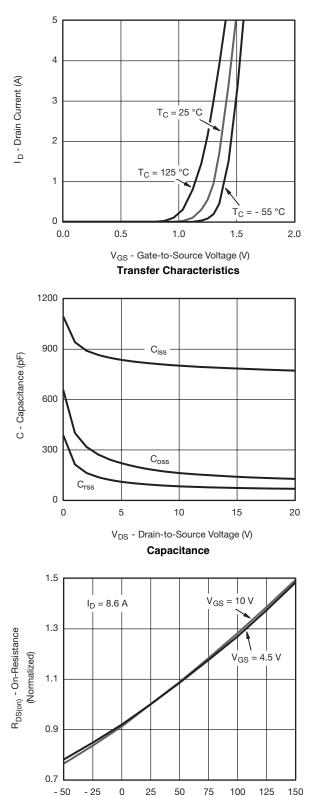


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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Gate Charge



T<sub>J</sub> - Junction Temperature (°C) **On-Resistance vs. Junction Temperature** 

75

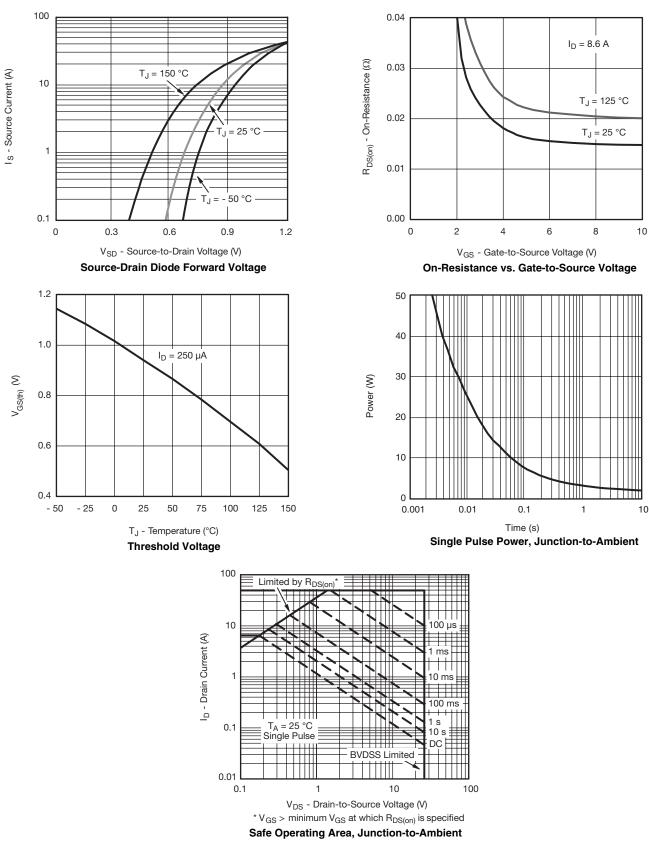
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Document Number: 66591 S10-1043-Rev. A, 03-May-10 125



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

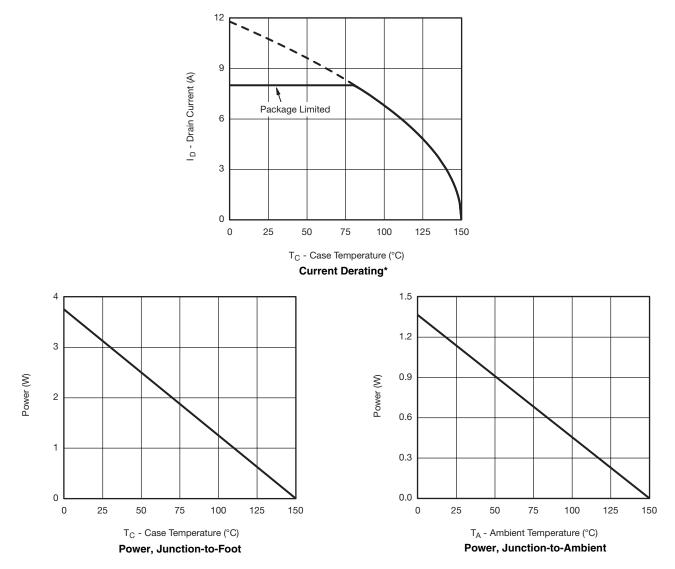


**New Product** 



### Si4228DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

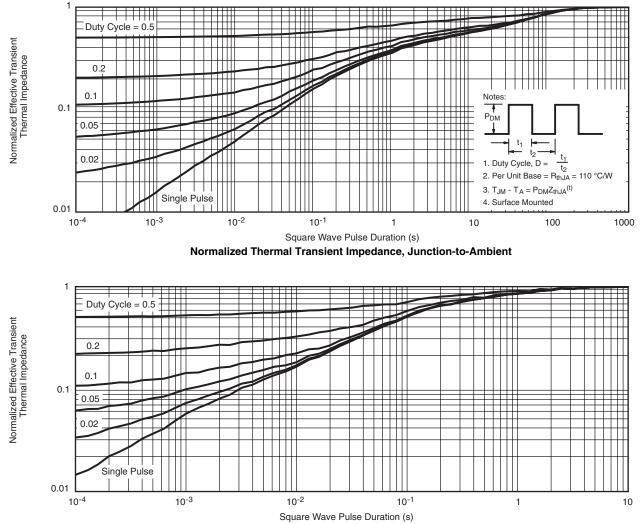


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?66591">www.vishay.com/ppg?66591</a>.



# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





|   | MILLIM | IETERS | INC       | HES   |  |
|---|--------|--------|-----------|-------|--|
| DIM   | Min    | Мах    | Min       | Max   |  |
| A   | 1.35   | 1.75   | 0.053     | 0.069 |  |
| A <sub>1</sub>                              | 0.10   | 0.20   | 0.004     | 0.008 |  |
| В   | 0.35   | 0.51   | 0.014     | 0.020 |  |
| С   | 0.19   | 0.25   | 0.0075    | 0.010 |  |
| D   | 4.80   | 5.00   | 0.189     | 0.196 |  |
| E   | 3.80   | 4.00   | 0.150     | 0.157 |  |
| е   | 1.27   | BSC    | 0.050 BSC |       |  |
| н   | 5.80   | 6.20   | 0.228     | 0.244 |  |
| h   | 0.25   | 0.50   | 0.010     | 0.020 |  |
| L   | 0.50   | 0.93   | 0.020     | 0.037 |  |
| q   | 0°     | 8°     | 0°        | 8°    |  |
| S   | 0.44   | 0.64   | 0.018     | 0.026 |  |
| ECN: C-06527-Rev. I, 11-Sep-06<br>DWG: 5498 |        |        |           |       |  |

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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